



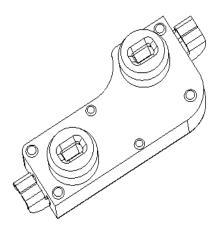


**Document Number:** 

KH-PS2110-09

# 产品规格书

## Product Specification



<u>P/N:</u>		Tit	tle:		
	CPG151101S11-4		1511 Connector		
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
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#### 1. Scope/范围:

This Product Specification covers the requirement of Mechanical keyboard Connector switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘连接器产品的要求,包括性能指标、测试方法及质量保证方面等。

#### 2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers equipment and Man-Machine interface.

主要适用于电脑, 收银机, 工业设备和人机界面

#### 3. Technology Parameters/技术参数

Ambient Humidity 工作湿度: 45~95% R.H.;

Operating Temperature Range 使用温度范围: -10  $^{\circ}$   $^{\circ}$  +60  $^{\circ}$   $^{\circ}$  Storage Temperature Range 保存温度范围: -20  $^{\circ}$   $^$ 

**Normal Condition:** 

Ambient temperature 环境温度: 20±2℃

Relative humidity 相对湿度: 85%±5% R.H.;

Air pressure 气压: 86~101KPa;

Contact Resistance 接触阻抗: 100 m Ω Max;

Solder Ability 可焊性: 260±5℃,3±0.5s;

Withstand Soldering Temperature 耐焊接热: 260±5℃,5±0.5s;

#### 4. Ratings/额定性能要求

Rating Voltare 额定电压: Rating Current 额定电流

InsulationResistance 绝缘电阻:

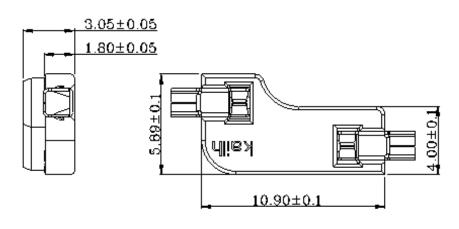
Withstand Voltage 耐电压:

Mechanical Life 机械寿命:

12V AC/DC max; 2V DC min 10mA AC/DC max; 10uA DC min ≥100MΩ/DC 500V;

AC 100V 1 Minute; 15000Cycles.

#### 5. Profile Dimensions /外形尺寸





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#### 6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心.  Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA)	
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 500V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
6.3	VOITSOR LACE AND A COLUMN TO THE AND A COLUMN		

### 7. Mechanical Performance/机械性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
7.1	Mating force 插入力	At 16in/minute.actuation speed	Mating force 插入力 3KG max



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7.2	Unmating force 拔出力	At 16in/minute.actuation speed	Unmating force 拔出力 200gf min
7.3	Shock 机械冲击	Measured by according to the below condition: (1) Acceleration: 80g 加速度 (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles. 试验次数: 每个方向 3 次,6 个方向共 18 次.	Appearance: No abnormality. 外观无异常
7.4	Life Test 寿命测试	<ul> <li>(1) No load 无负载</li> <li>(2) Mating force: Maximum value of operation force. 插入力: 操作力规格值的上限.</li> <li>(3) Cycles: 15000 Min 操作次数: 15000 次以上</li> </ul>	Contact resistance: 1000 m Ω Max 接触电阻: 1000 毫欧以下 Bouncing: 10ms Max

#### 8. Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
8.1	Cold test 耐寒性	(1) Temperature: - 20±2℃ 温度: - 20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max 接触电阻 200m Ω以下



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8.2	Heat test 耐热性	<ul> <li>(1) Temperature: 70±2℃</li> <li>温度: 70±2℃</li> <li>(2) Duration of test: 48h</li> <li>持续时间: 48 小时</li> <li>(3) Take off a drop water 去掉水珠</li> <li>(4) Standard conditions after test: 1h</li> <li>试验后的放置条件: 1 小时</li> </ul>	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2	
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期: 5 个周期 (2) Standard condition after test:1h 试验后的放置条件: 1 小时  Temperature Duration of test 持续时间 20±5℃ 1h 1 cycle -次循环 -20±5℃ 1h 20±5℃ 1h 70±5℃ 1h	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2	
8.4	Soldering heat test 耐焊接热	Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积: 印刷基板的 1/2 厚度处 Soldering temperature: 260±5℃ Soldering time: 5±0.5s 焊接温度: 260±5℃ 焊接时间: 5±0.5 秒	Appearance: No abnormality. 外观无异常	
8.5	Solderability 可焊性	<ol> <li>Hand soldering 手工焊接: Please practice according to below condition:         <ul> <li>(1) Soldering Temperature: 350±5℃ 焊接温度: 350±5℃</li> <li>(2) Continual soldering time: 3±0.5s 连续焊接时间: 3±0.5 秒</li> <li>(3) Capacity of soldering iron: ≤20w 电烙铁功率: 20 瓦以下</li> </ul> </li> <li>Automatic Reflow soldering 自动回流焊接: For the product of SMT, according to below condition:</li> </ol>	At least 90% of surface area of immersed portion shall be covered by solder. 侵焊面积大于 95%以上.	



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8.6	Humidity test 耐湿性	<ul> <li>(1) Temperature: 60±2℃ 温度: 60±2℃</li> <li>(2) relative humidity: 90~95% R.H. 相对湿度:90~95% R.H.</li> <li>(3) Duration of test: 48h 持续时间: 48 小时</li> <li>(4) Take off a drop water 去掉水珠</li> <li>(5) Standard conditions after test: 1h 试验后的放置条件: 1 小时</li> </ul>	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2		
8.7	Salt Spray 盐雾测试	Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12 hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材.  Contact Resistance: 200 mΩ Max 接触电阻: 200 毫欧以下		



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8.8	Withstand K <sub>2</sub> S 硫化测试	Apply the following env 根据下列条件进行测试 (1) Temperature: 35±5 (2) K <sub>2</sub> S Density: 2%; 硫化钾浓度: 2% (3) Duration: 2 minute. 持续时间: 2分钟			Appearan No corros crack, no naked. 外观: 无原 无裸露基 Contact R 1000 m Ω 接触电阻: 下	ion spot, base plat 爾蚀点,无 材. desistance Max	e 裂纹, e:



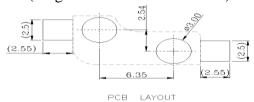
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#### 9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

(Top View)

(Single face board T=1.6mm)



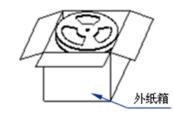
#### 10. Packaging 包装

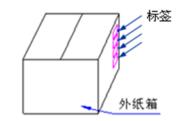
Packaging type: 13Tray, 26000Pcs/Carton.

包装方式:13/盘, 26000Pcs/箱.



卷盘





11.Precaution 注意事项 11.1 Soldering condition 回流焊条件

11.1 Soldering condition				
ITEM		CONDITION		
项目		条件		
	Heating zone 升温区	Speed<2°C/S,Preheating time15 S Max,temperture150°C 速度<2°C/S,预热时间 15 S 最多,温度 150°C		
Preheating zone 预热区	Heatpreservati on area 保温区	Speed1. 2~3. 5℃/S,Preheating time120 S Max,temperture180℃ 速度 1. 2~3. 5℃/S,预热时间 120 S 最多,温度 180℃		
	Fast heating zone 快速升温区	Speed3. 5~4. 5℃/S, Preheating time140 S Max,temperture230℃ 速度 3. 5~4. 5℃/S,预热时间 140 S 最多,温度 230℃		
Weld area 焊接区		Welding time 40 S Max ,welding temperature peak value,3 sec Max. 焊接时间 40 S 最多,焊接温度峰值 260℃ 最大,3 S 最多		
Area of flux 助焊剂面积		1/2 Max of PWB Thickness 印刷基板厚度的 1/2 以内		
Temperature of solder 焊锡温度		260±5℃ 260±5℃		
Number of solder 焊接次数	ing	2time Max (But should down heat of the first soldering) 2 次以内		
Printed wiring boo 印刷基板	ard	Single side copper-clad laminates 单面铜箔		

(1) After reflow, be careful not to clean switches with solvent

回流焊后,注意不要用溶剂清洗.

(2) Under the condition of using soldering iron, soldering temperature shall be 350°C max within 3 sec. 在使用铬铁的情况下,焊锡温度应在350℃以下,焊接时间3秒以内.



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#### 11.2 Notes 注意点

- (1) Please be cautious not to give excessive static load connector. 注意不要施加超负荷的压力或晃动连接器.
- (2) Connector be careful not to stack up P. W. B. after switches were soldered. 连接器焊接以后,印刷基板注意不要叠放.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
  - 保存标准为 3 个月,限度为 6 个月以内,请尽早使用. 打开包装后,有剩余品时,应将剩余部分以胶袋包装好以同外界隔离,请进行合适的防湿,防腐蚀气体等处理后进行保管.
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